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HMC747* Product Page Quick Links

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Comparable Parts

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Evaluation Kits

HMC747LC3C Evaluation Board

Documentation 🖵

Data Sheet

• HMC747 Data Sheet

Reference Materials

Quality Documentation

- Package/Assembly Qualification Test Report: LC3, LC3B, LC3C (QTR: 2014-00376 REV: 01)
- Semiconductor Qualification Test Report: BiCMOS-C (QTR: 2013-00241)

Technical Articles

• A New 13 Gbps/13 GHz +3.3V High Speed Logic Family

Design Resources 🖵

- HMC747 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

Discussions 🖵

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Sample and Buy

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Technical Support

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HMC747LC3C



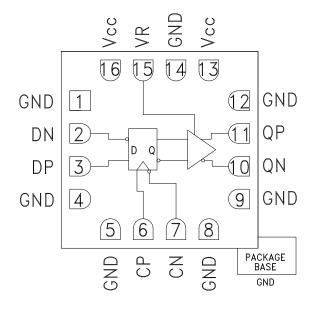
14 Gbps, FAST RISE TIME D-TYPE FLIP-FLOP w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

Typical Applications

The HMC747LC3C is ideal for:

- RF ATE Applications
- Broadband Test & Measurement
- Serial Data Transmission up to 14 Gbps
- Digital Logic Systems up to 14 GHz

Functional Diagram



Features

Supports High Data Rates: up to 14 Gbps Differential & Single-Ended Operation Fast Rise and Fall Times: 22 / 20 ps Low Power Consumption: 264 mW typ. Programmable Differential Output Voltage Swing: 700 - 1300 mV Propagation Delay: 105 ps Single Supply: +3.3 V 16 Lead Ceramic 3x3 mm SMT Package: 9 mm²

General Description

The HMC747LC3C is a D-Type Flip-Flop designed to support data transmission rates of up to 14 Gbps, and clock frequencies as high as 14 GHz. During normal operation, data is transferred to the outputs on the positive edge of the clock. Reversing the clock inputs allows for negative-edge triggered applications.

All differential inputs to the HMC747LC3C are CML and terminated on-chip with 50 ohms to the positive supply, Vcc, and may be AC or DC coupled. The differential CML outputs are source terminated to 50 ohms and may also be AC or DC coupled. Outputs can be connected directly to a 50 ohm Vcc-terminated system, while DC blocking capacitors may be used if the terminating system is 50 ohms to ground. The HMC747LC3C also features an output level control pin, VR, which allows for loss compensation or signal-level optimazation. the HMC747LC3C operates from a single 3.3 V supply and is available in ROHS-compliant 3x3 mm SMT package.

Electrical Specifications, $T_A = +25$ °C, $V_{CC} = 3.3 V$, VR = 3.3 V

Parameter	Conditions	Min.	Тур.	Мах	Units
Power Supply Voltage		3.0	3.3	3.6	V
Power Supply Current			80		mA
Maximum Data Rate			14		Gbps
Maximum Clock Rate			14		GHz
Input Voltage Range		Vcc - 1.5		Vcc + 0.5	V
Input Differential Range		0.1		2	Vp-p
Input Return Loss	Frequency <14 GHz		10		dB
	Single-Ended, peak-to-peak		550		mVp-p
Output Amplitude	Differential, peak-to-peak		1100		mVp-p
Output High Voltage			3.29		V



HMC747LC3C

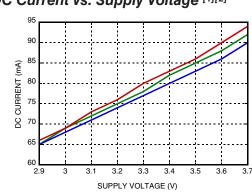


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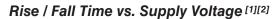
Electrical Specifications (continued)

Parameter	Conditions	Min.	Тур.	Max	Units
Output Low Voltage			2.74		V
Output Rise / Fall Time	Differential, 20% - 80%		22 / 20		ps
Output Return Loss	Frequency <13 GHz		10		dB
Random Jitter Jr	rms			0.2	ps rms
Deterministic Jitter, Jd	peak-to-peak, 2 ¹⁵ -1 PRBS input ^[1]		2		ps, p-p
Propagation Delay Clock to Data, td			105		ps
Clock Phase Margin	13 GHz		320		deg
Set Up & Hold Time, t _{SH}			6		ps
VR Pin Current	VR = 3.3 V		2		mA
VR Pin Current	VR = 3.7 V			3.5	mA

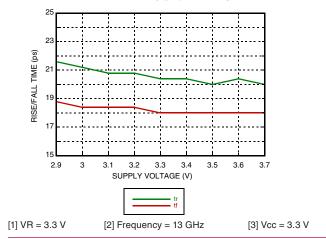
[1] Deterministic jitter calculated by simultaneously measuring the jitter of a 300 mV, 13 GHz, 2¹⁵-1 PRBS input, and a single-ended output



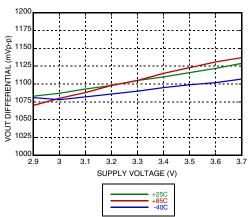
DC Current vs. Supply Voltage [1][2]



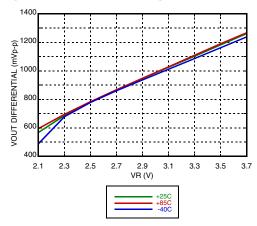
+25C +85C -40C



Output Differential Voltage vs. Supply Voltage [1][2]



Output Differential Voltage vs. VR [1][2]



3.6 3.7

HIGH SPEED LOGIC - SMT

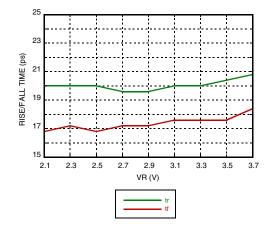


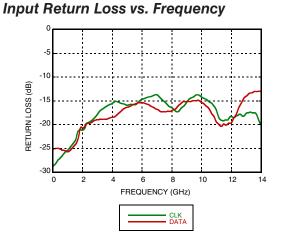


RoHS V

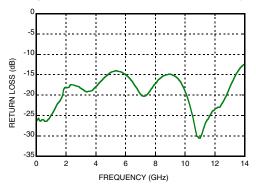
14 Gbps, FAST RISE TIME D-TYPE FLIP-FLOP w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

Rise / Fall Time vs. VR [1][2]





Output Return Loss vs. Frequency



[1] Vcc = 3.3 V [2] Frequency = 13 GHz

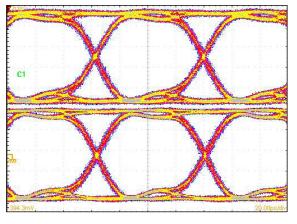


HMC747LC3C

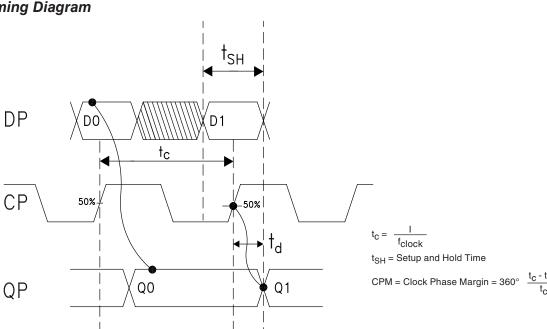


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Eye Diagram



Timing Diagram



Truth Table

Input		Outputs
D	С	Q
L	L -> H	L
Н	L -> H	Н
Notes: D = DP - DN C = CP - CN Q = QP - QN	H - Positive voltage level L - Negative voltage level	

[1] Test Conditions: Pattern generated with an Agilent N4903A Serial BERT. Eye Diagram presented on a Tektronix CSA 8000. Device input = 13 Gbps PN code. Both output channels shown. Device is AC coupled to scope.

t_c - t_{SH} tc





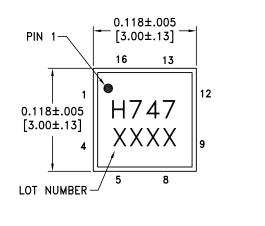
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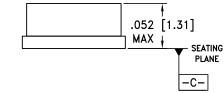
Absolute Maximum Ratings

Power Supply Voltage (Vcc)	Vcc -0.5 V to 3.75 V	
Input Signals	Vcc - 2.0 V to Vcc + 0.5 V	
Output Signals	Vcc - 1.5 V to Vcc + 0.5 V	
Continuous Pdiss (T = 85 °C) (derate 17 mW/°C above 85 °C)	0.68 W	
Thermal Resistance (R _{th j-p}) worst case junction to package paddle	59 °C/W	
Maximum Junction Temperature	125 °C	
Storage Temperature	-65 °C to +150 °C	
Operating Temperature	-40 °C to +85 °C	
ESD Sensitivity (HBM)	Class 1C	

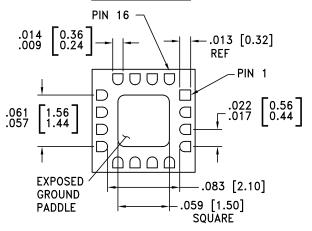


Outline Drawing





BOTTOM VIEW



NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA

2. LEAD AND GROUND PADDLE PLATING

30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL. 3. DIMENSIONS ARE IN INCHES [MILLIMETERS].

4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.

5. PACKAGE WARP SHALL NOT EXCEED 0.05 mm DATUM -C-

6. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

7. PADDLE MUST BE SOLDERED TO GND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[2]
HMC747LC3C	Alumina, White	Gold over Nickel	MSL3 ^[1]	H747 XXXX

Max peak reflow temperature of 260 °C
4-Digit lot number XXXX





14 Gbps, FAST RISE TIME D-TYPE FLIP-FLOP w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

Pin Descriptions

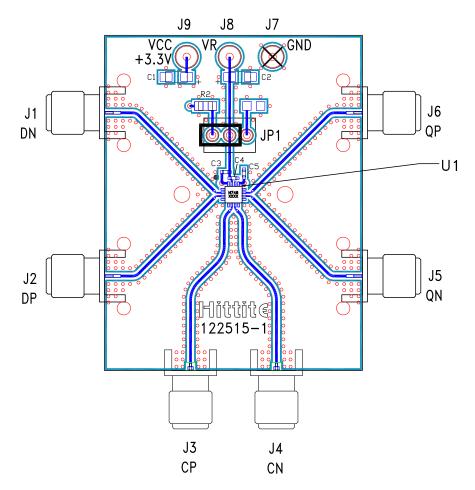
Pin Number	Function	Description	Interface Schematic
1, 4, 5, 8, 9, 12	GND	Signal Grounds	
2, 3 6, 7	DN, DP CP, CN	Differential Data Inputs: Current Mode Logic (CML) referenced to positive supply.	
10, 11	QN, QP	Differential Data Outputs: Current Mode Logic (CML) referenced to positive supply.s	
13, 16	Vcc	Positive Supply	
14, Package Base	GND	Supply Ground	
15	VR	Output level control. Output level may be adjusted by applying a voltage to VR per "Output Differential vs. VR" plot.	VR 0





14 Gbps, FAST RISE TIME D-TYPE FLIP-FLOP w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

Evaluation PCB



List of Materials for Evaluation PCB EVAL01-HMC747LC3C ^[1]

Item	Description	
J1 - J6	PCB Mount SMA RF Connectors	
J7 - J9	DC Pin	
JP1	Shorting Jumper	
C1, C2	4.7 µF Capacitor, Tantalum	
C3 - C5	100 pF Capacitor, 0402 Pkg.	
R2	10 Ohm Resistor, 0603 Pkg.	
U1	HMC747LC3C High Speed Logic, D-Type Flip-Flop	
PCB ^[2]	122515 Evaluation Board	

Reference this number when ordering complete evaluation PCB
Circuit Board Material: Arlon 25FR or Rogers 4350

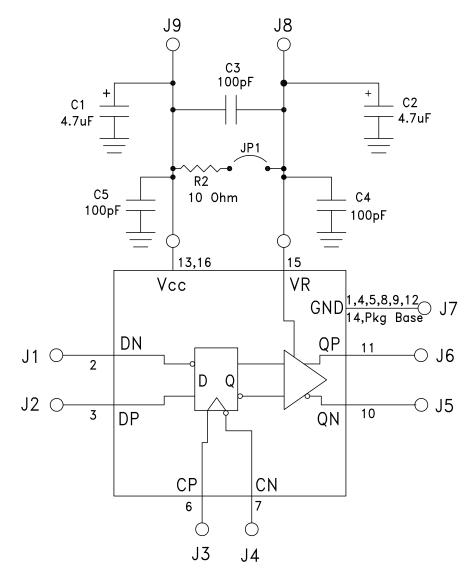
The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package gro-und leads should be connected directly to the ground plane similar to that shown. The exposed package base should be connected to GND. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request. Install jumper on JP1 to short VR to Vcc for normal operation.



ROHS CEP

14 Gbps, FAST RISE TIME D-TYPE FLIP-FLOP w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

Application Circuit



HIGH SPEED LOGIC - SMT